



MMDT4413

COMPLEMENTARY PAIR SMALL SIGNAL TRANSISTOR IN SOT363

Features

- Epitaxial Die Construction
- Two Internally Isolated NPN/PNP Transistors in One Package

NPN = 4401

PNP = 4403

- Ideal for Medium Power Amplification and Switching
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

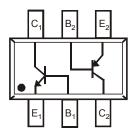
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.006 grams (approximate)





Top View



Device Schematic Top View

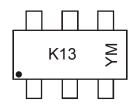
Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
MMDT4413-7-F	K13	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



K13= Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	2010	201	11	2012	20	013	2014	2	2015	2016		2017
Code	Х	Y		Z		A	В		С	D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings: NPN, 4401 Type (Q₁) (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	60	V
Collector-Emitter Voltage	V _{CEO}	40	V
Emitter-Base Voltage	V _{EBO}	6	V
Collector Current	Ic	600	mA

Absolute Maximum Ratings: PNP, 4403 Type (Q2) (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-5	V
Collector Current	lc	-600	mA

Thermal Characteristics – Total Device (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) Total Device	P _D	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Note:

Thermal Characteristics - Total Device

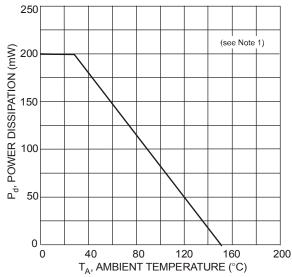


Fig. 1, Power Derating Curve (Total Device)

^{5.} For a device mounted on minimum recommended pad layout with 1oz copper that is on a single-sided 1.6mm FR4 PCB; the device is measured under still air conditions whilst operating in a steady-state.

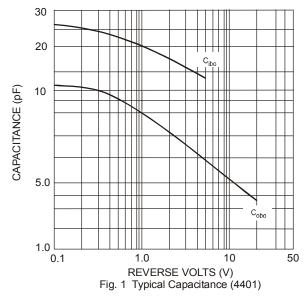


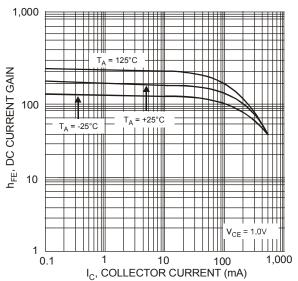
Electrical Characteristics, NPN 4401 Section (@T_A = +25°C unless otherwise specified.)

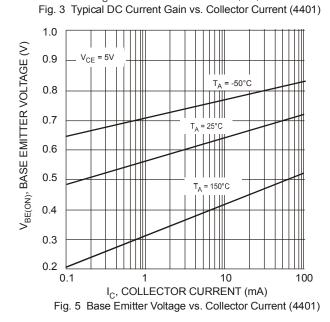
Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)					
Collector-Base Breakdown Voltage	BV _{CBO}	60	_	V	$I_C = 100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	BV _{CEO}	40	_	V	I _C = 1.0mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	6.0		V	$I_E = 100 \mu A, I_C = 0$
Collector Cutoff Current	I _{CEX}	_	100	nA	V _{CE} = 35V, V _{EB(OFF)} = 0.4V
Base Cutoff Current	I _{BL}	_	100	nA	V _{CE} = 35V, V _{EB(OFF)} = 0.4V
ON CHARACTERISTICS (Note 6)			•	·	•
DC Current Gain	h _{FE}	20 40 80 100 40	 300 	_	$I_{C} = 100 \mu A, V_{CE} = 1.0 V$ $I_{C} = 1.0 m A, V_{CE} = 1.0 V$ $I_{C} = 10 m A, V_{CE} = 1.0 V$ $I_{C} = 150 m A, V_{CE} = 1.0 V$ $I_{C} = 500 m A, V_{CE} = 2.0 V$
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	0.40 0.75	V	I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	0.75 —	0.95 1.2	V	I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{cb}	_	6.5	pF	$V_{CB} = 5.0V$, $f = 1.0MHz$, $I_E = 0$
Input Capacitance	C _{eb}	_	30	pF	V _{EB} = 0.5V, f = 1.0MHz, I _C = 0
Input Impedance	h _{ie}	1.0	15	kΩ	
Voltage Feedback Ratio	h _{re}	0.1	8.0	x 10 ⁻⁴	V _{CE} = 10V, I _C = 1.0mA, f = 1.0kHz
Small Signal Current Gain	h _{fe}	40	500	_	VCE - 10V, IC - 1.0IIIA, I - 1.0KHZ
Output Admittance	h _{oe}	1.0	30	μS	
Current Gain-Bandwidth Product	f⊤	250	_	MHz	$V_{CE} = 10V, I_{C} = 20mA,$ f = 100MHz
SWITCHING CHARACTERISTICS					
Delay Time	t _d		15	ns	$V_{CC} = 30V, I_{C} = 150mA,$
Rise Time	t _r	_	20	ns	$V_{BE(off)} = 2.0V, I_{B1} = 15mA$
Storage Time	ts	_	225	ns	V _{CC} = 30V, I _C = 150mA,
Fall Time	t _f	_	30	ns	$I_{B1} = I_{B2} = 15mA$

Note: 6. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%









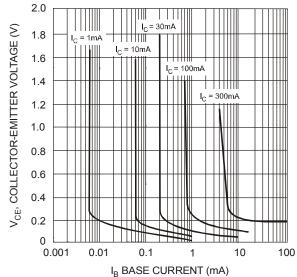


Fig. 2 Typical Collector Saturation Region (4401)

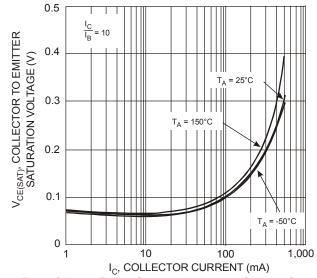


Fig. 4 Collector Emitter Saturation Voltage vs. Collector Current (4401)

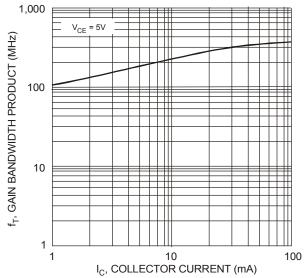


Fig. 6 Gain Bandwidth Product vs. Collector Current (4401)

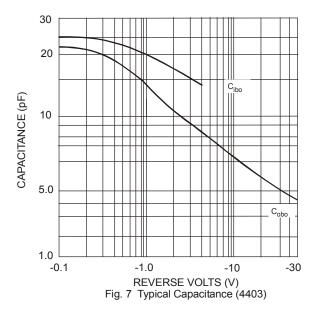


Electrical Characteristics, PNP 4403 Section (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)							
Collector-Base Breakdown Voltage	BV _{CBO}	-40	_	V	$I_C = -100\mu A, I_E = 0$		
Collector-Emitter Breakdown Voltage	BV _{CEO}	-40	_	V	$I_C = -1.0 \text{mA}, I_B = 0$		
Emitter-Base Breakdown Voltage	BV _{EBO}	-5.0	_	V	$I_E = -100 \mu A, I_C = 0$		
Collector Cutoff Current	I _{CEX}	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$		
Base Cutoff Current	I _{BL}	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$		
ON CHARACTERISTICS (Note 6)							
DC Current Gain	h _{FE}	30 60 100 100 20	 300 	_	$I_{C} = -100\mu A, V_{CE} = -1.0V$ $I_{C} = -1.0mA, V_{CE} = -1.0V$ $I_{C} = -10mA, V_{CE} = -1.0V$ $I_{C} = -150mA, V_{CE} = -2.0V$ $I_{C} = -500mA, V_{CE} = -2.0V$		
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	-0.40 -0.75	V	I_C = -150mA, I_B = -15mA I_C = -500mA, I_B = -50mA		
Base-Emitter Saturation Voltage	V _{BE(SAT)}	-0.75 —	-0.95 -1.30	V	I_C = -150mA, I_B = -15mA I_C = -500mA, I_B = -50mA		
SMALL SIGNAL CHARACTERISTICS							
Output Capacitance	C _{cb}	_	8.5	pF	$V_{CB} = -10V$, $f = 1.0MHz$, $I_E = 0$		
Input Capacitance	C _{eb}	_	30	pF	$V_{EB} = -0.5V$, $f = 1.0MHz$, $I_C = 0$		
Input Impedance	h _{ie}	1.5	15	kΩ			
Voltage Feedback Ratio	h _{re}	0.1	8.0	x 10 ⁻⁴	V _{CE} = -10V, I _C = -1.0mA, f = 1.0kHz		
Small Signal Current Gain	h _{fe}	60	500	_	VCE = -10V, IC = -1.0IIIA, I = 1.0KIIZ		
Output Admittance	h _{oe}	1.0	100	μS			
Current Gain-Bandwidth Product	f⊤	200	_	MHz	$V_{CE} = -10V$, $I_{C} = -20mA$, $f = 100MHz$		
SWITCHING CHARACTERISTICS							
Delay Time	t _d		15	ns	$V_{CC} = -30V, I_{C} = -150mA,$		
Rise Time	t _r	_	20	ns	$V_{BE(off)} = -2.0V$, $I_{B1} = -15mA$		
Storage Time	t _s	_	225	ns	V _{CC} = -30V, I _C = -150mA,		
Fall Time	t _f	_	30	ns	$I_{B1} = I_{B2} = -15\text{mA}$		

Note: 6. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%





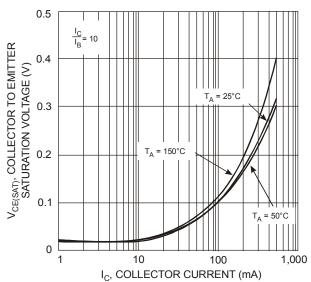


Fig. 9 Collector Emitter Saturation Voltage vs. Collector Current (4403)

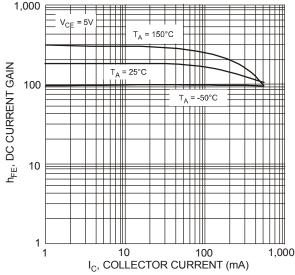


Fig. 11 DC Current Gain vs. Collector Current (4403)

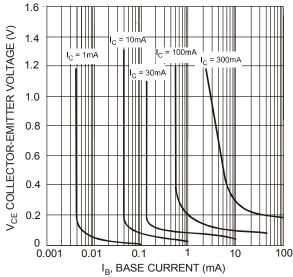


Fig. 8 Typical Collector Saturation Region (4403)

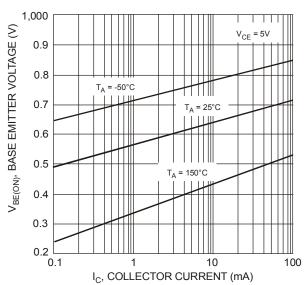
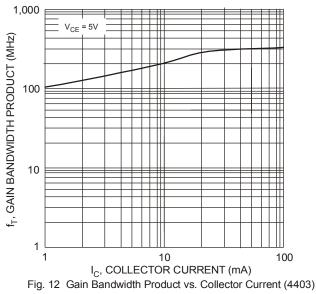


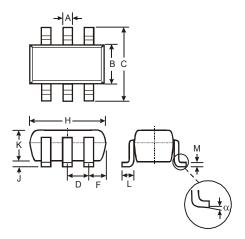
Fig. 10 Base-Emitter Voltage vs. Collector Current (4403)





Package Outline Dimensions

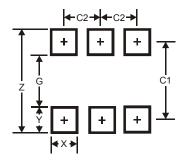
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT363						
Dim	Min	Max	Тур				
Α	0.10	0.30	0.25				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	0.65 Typ						
F	0.40	0.45	0.425				
Н	1.80	2.20	2.15				
J	0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.22	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Υ	0.6
C1	1.9
C2	0.65



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